

### **Vishay Siliconix**

### Dual P-Channel 60-V (D-S) MOSFET

#### **CHARACTERISTICS**

- P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

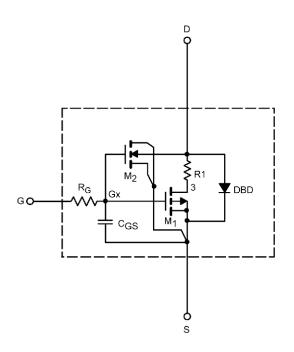
- Apply for both Linear and Switching Application
- Accurate over the 55 °C to 125 °C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

#### DESCRIPTION

The attached spice model describes the typical electrical characteristics of the P-channel vertical DMOS. The subcircuit mode is extracted and optimized over the - 55  $^{\circ}$ C to 125  $^{\circ}$ C temperature ranges under the pulsed 0 V to 10 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

#### SUBCIRCUIT MODEL SCHEMATIC

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched  $C_{gd}$  model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.

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SPECIFICATIONS (T <sub>j</sub> = 25 °C UNLESS OTHERWISE NOTED)					
Parameter	Symbol	Test Condition	Simulated Data	Measured Data	Unit
Static					
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{_{DS}} = V_{_{GS}}$ , $I_{_{D}} = -250 \ \mu A$	2		V
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{_{DS}} = -5 V, V_{_{GS}} = -10 V$	99		А
Drain-Source On-State Resistance <sup>b</sup>	$R_{\scriptscriptstyle DS(on)}$	$V_{_{GS}} = -10 \text{ V}, \text{ I}_{_{D}} = -5 \text{ A}$	0.050	0.051	Ω
		$V_{_{GS}} = -4.5 \text{ V}, \text{ I}_{_{D}} = -4.5 \text{ A}$	0.063	0.064	
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	$V_{_{\rm DS}} =$ - 15 V, $I_{_{\rm D}} =$ - 5 A	15	16	S
Diode Forward Voltage <sup>b</sup>	V <sub>SD</sub>	$I_{_{\rm S}}$ = - 2.9 A, $V_{_{\rm GS}}$ = 0 V	- 0.83	- 0.80	V
Dynamic <sup>a</sup>					
Total Gate Charge	Q	$V_{_{DS}} = -30 \text{ V}, \text{ V}_{_{GS}} = -10 \text{ V}, \text{ I}_{_{D}} = -5 \text{ A}$	24	26	nC
Gate-Source Charge	Q <sub>gs</sub>		4.5	4.5	
Gate-Drain Charge	$Q_{gd}$		7	7	

Notes

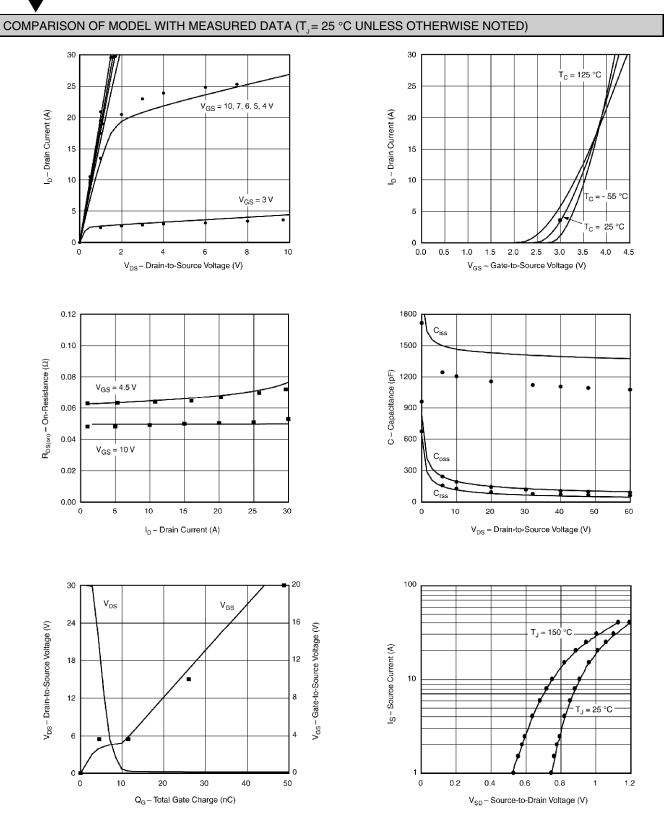
a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.

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# SPICE Device Model Si7949DP

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Note: Dots and squares represent measured data.

Document Number: 64075 S-82045-Rev. A, 01-Sep-08



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